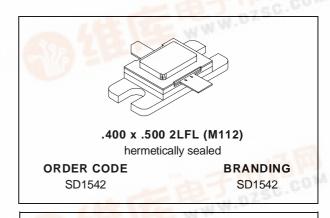
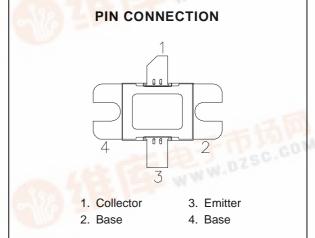


SD1542

RF & MICROWAVE TRANSISTORS AVIONICS APPLICATIONS

- DESIGNED FOR HIGH POWER PULSED IFF AND DME APPLICATIONS
- 600 WATTS (typ.) IFF 1030/1090 MHz
- 550 WATTS (min.) DME 1025 1150 MHz
- 5.6 dB MIN. GAIN
- REFRACTORY GOLD METALLIZATION
- BALLASTING AND LOW THERMAL RESISTANCE FOR RELIABILITY AND RUGGEDNESS
- 30:1 LOAD VSWR CAPABILITY AT SPECIFIED OPERATING CONDITIONS
- INTERNAL INPUT/OUTPUT MATCHED, COMMON BASE CONFIGURATION





DESCRIPTION

The SD1542 is a hermetically sealed, gold metallized, silicon NPN power transistor. The SD1542 is designed for applications requiring high peak power and low duty cycles such as IFF and DME. The SD1542 is packaged in a hermetic metal/ceramic package with internal input/output matching, resulting in improved broadband performance and a low thermal resistance.

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C)

Symbol	Parameter	Value	Unit
Vсво	Collector-Base Voltage	65	V
Vces	Collector-Emitter Voltage	65	V
V _{EBO}	Emitter-Base Voltage	3.5	V
Ic	Device Current	40	А
P _{DISS} Power Dissipation		1350	W
TJ	Junction Temperature	+200	°C
T _{STG}	Storage Temperature	- 65 to +200	°C

THERMAL DATA

R _{TH(j-c)}	Junction-Case Thermal Resistance	0.06	°C/W
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1/4

ELECTRICAL SPECIFICATIONS (Tcase = 25°C)

STATIC

Symbol	Test Conditions		Value			Unit	
			Min.	Тур.	Max.	Oilit	
ВУсво	I _C = 25mA	$I_E = OmA$		65	_	_	V
BVces	I _C = 50mA	$V_{BE} = 0V$		65	_	_	V
BV _{EBO}	I _E = 10mA	$I_C = 0mA$		3.5	_	_	V
Ices	V _{CE} = 50V	$I_E = OmA$		_	_	35	mA
h _{FE}	V _{CE} = 5V	$I_C = .25A$		5	_	200	_

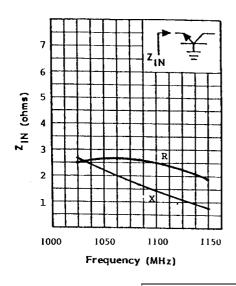
DYNAMIC

Symbol	Test Conditions		Value		Unit	
Symbol	Symbol Test Conditions			Тур.	Max.	Unit
Роит	f = 1025 — 1150MHz P _{IN} = 150 W V _C	E = 50 V	550			W
G _P	f = 1025 — 1150MHz P _{IN} = 150 W V _C	e = 50 V	5.6			dB

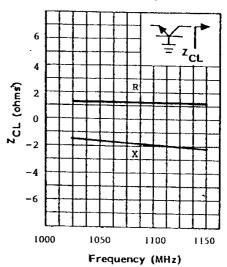
Note: Pulse Width = 10μ Sec, Duty Cycle = 1%

IMPEDANCE DATA

TYPICAL INPUT IMPEDANCE



TYPICAL COLLECTOR LOAD IMPEDANCE

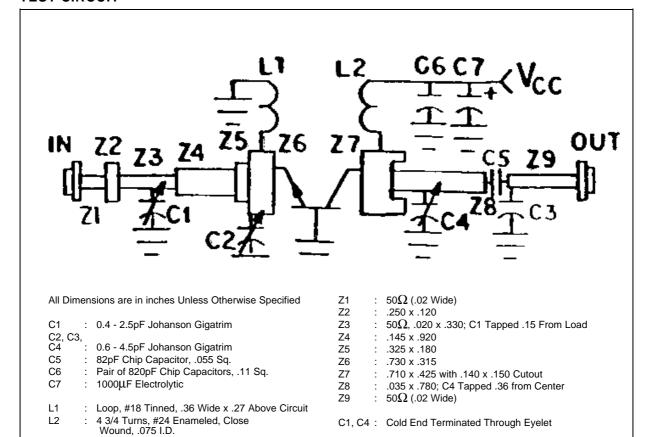


FREQ.		$Z_{IN} \; (\Omega)$	$Z_CL\ (\Omega)$
10)20 MHz	1.78 + j 3.0	1.33 – j 2.7
10)90 MHz	1.57 + j 2.1	1.64 – j 3.4
11	I50 MHz	1.55 + j 1.4	1.93 – j 4.0

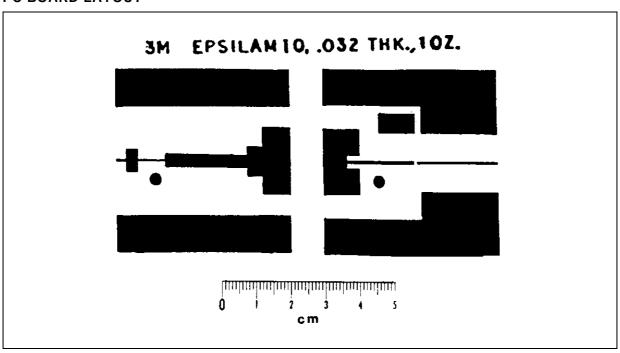
 $P_{IN} = 150 \text{ W}$ $V_{CE} = 50 \text{ V}$



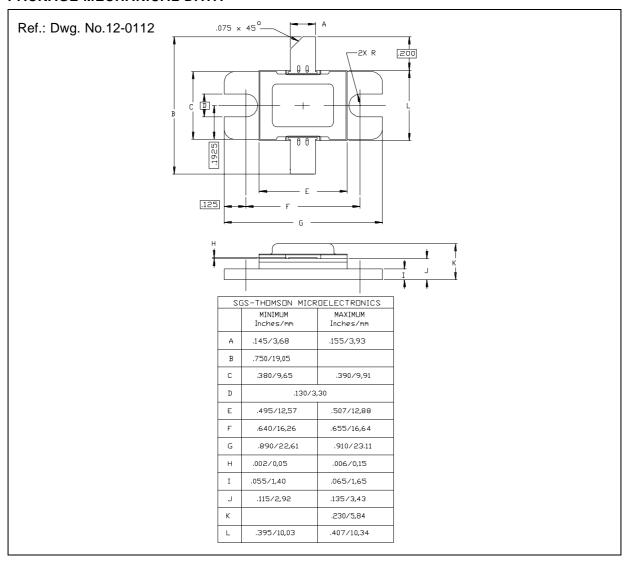
TEST CIRCUIT



PC BOARD LAYOUT



PACKAGE MECHANICAL DATA



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